

# PIC18F06/16Q41 Silicon Errata and Data Sheet

## Clarifications

### PIC18F06/16Q41



The PIC18F06/16Q41 devices you have received conform functionally to the current device data sheet (DS40002214E), except for the anomalies described in this document.

The silicon issues discussed in the following pages are for silicon revisions with the Device and Revision IDs listed in the table below.

The errata described in this document will be addressed in future revisions of the PIC18F06/16Q41 silicon.

**Note:** This document summarizes all silicon errata issues from all revisions of silicon, previous as well as current.

**Table 1.** Silicon Device Identification

Part Number	Device ID	Revision ID			
		A4	A5	A6	B1
PIC18F06Q41	0x7580	0xA004	0xA005	0xA006	0xA041
PIC18F16Q41	0x7560	0xA004	0xA005	0xA006	0xA041



**Important:** Refer to the **Device/Revision ID** section in the current **“PIC18-Q41 Family Programming Specification”** (DS40002143) for more detailed information on Device Identification and Revision IDs for a specific device.

**Table 2.** Silicon Issue Summary

Module	Feature	Item No.	Issue Summary	Affected Revisions			
				A4	A5	A6	B1
Analog-to-Digital Converter with Computation	ADCC	1.1.1	ADC cannot operate in certain low-power conditions	X			
		1.1.2	Double Sample Conversions	X	X	X	
Oscillator	XT mode	1.2.1	Maximum clock frequency limited to 2 MHz for XT mode	X			
	Fail-Safe Clock Monitor	1.2.2	Enabling the FOSC Fail-Safe Clock Monitor alongside the Primary or Secondary Oscillator Clock Monitor causes issues in Sleep	X			
	EC mode	1.2.3	Maximum clock frequency for EC mode is 32 MHz for $V_{DD} < 2.0V$	X			
I <sup>2</sup> C	I <sup>2</sup> C	1.3.1	I <sup>2</sup> CxADR0/1/2/3 registers have incorrect Reset value	X			
		1.3.2	I <sup>2</sup> C Start and/or Stop Flags May be Set When I <sup>2</sup> C is Enabled	X	X		
		1.3.3	MDR bit is not cleared after Bus Timeout	X	X	X	X
		1.3.4	Bus Timeout not detected properly when External Host Clock stretches	X	X	X	X
		1.3.5	Clock Stretch Disable not working properly	X	X	X	X
		1.3.6	Bus Timeout causes false Start/Stop	X	X	X	X
		1.3.7	CSTR bit is not cleared after bus time-out	X	X	X	X
		1.3.8	Operating in Multi-Host Mode will cause bus failures	X	X	X	X
	Multi-Host Mode						

.....continued

Module	Feature	Item No.	Issue Summary	Affected Revisions			
				A4	A5	A6	B1
Operational Amplifier	OPA	1.4.1	Charge Pump On Control (CPON) bit is reserved	X			
		1.4.2	Internal resistor ladder does not disconnect in Unity Gain mode	X			
Universal Asynchronous Receiver Transmitter	UART	1.5.1	UART TXDE signal may go low before the STOP bit has been entirely transmitted.	X	X	X	
		1.5.2	Asynchronous 9-bit UART Address Mode Address Mismatch	X	X	X	
Signal Measurement Timer	SMT	1.6.1	Reset Bit	X	X	X	
PIC18 CPU	FSR Shadow Registers	1.7.1	FSR Shadow Registers are not Writable	X	X	X	
ICSP™	Low-Voltage Programming (LVP)	1.8.1	Low Voltage Programming is not possible when VDD is below BORV while BOR is enabled.	X	X	X	

**Note:** Only those issues indicated in the last column apply to the current silicon revision.

## 1. Silicon Errata Issues

**CAUTION**

**Notice:** This document summarizes all silicon errata issues from all revisions of silicon, previous and current. Only the issues indicated by the bold font in the following tables apply to the current silicon revision.

### 1.1 Module: Analog-to-Digital Converter with Computation (ADCC)

#### 1.1.1 ADC Cannot Operate in Certain Low-Power Conditions

The ADC will not function when all of the following conditions exist: When the MCU system clock is sourced from LFINTOSC or SOSC and when both the BOR and FVR features are disabled.

##### Work around

- Method 1: Use a system clock other than LFINTOSC or SOSC.
- Method 2: Enable the BOR feature.
- Method 3: Enable the FVR feature.

##### Affected Silicon Revisions

A4	A5	A6	B1
X			

#### 1.1.2 Double Sample Conversions

When enabling a Double Sample Conversion (DSEN = 1) with no Precharge time (ADPRE = 0) and no Acquisition time (ADACQ = 0), the maximum number of cycles of acquisition time is inserted prior to the second conversion. The first conversion will be performed as expected with no Precharge time and no Acquisition time. It is only between the first and second conversions where a maximum number of cycles of Acquisition time is performed unexpectedly.

##### Work around

###### Method 1:

Disable Double Sample Conversion (DSEN = 0) and perform two single conversions back to back.

###### Method 2:

If adding acquisition time is acceptable, then select no Precharge time, along with the desired Acquisition time.

##### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	

### 1.2 Module: Oscillator (OSC)

#### 1.2.1 Maximum Clock Frequency Limited to 2 MHz for XT Mode

The maximum clock frequency for the intermediate gain setting that supports quartz crystal and ceramic resonator operation (XT mode) is being reduced from 4 MHz to 2 MHz.

##### Work around

For crystal or resonator frequencies above 2 MHz, use HS mode.

### Affected Silicon Revisions

A4	A5	A6	B1
X			

## 1.2.2 Enabling the FOSC Fail-Safe Clock Monitor Alongside the Primary or Secondary Oscillator Clock Monitor Causes Issues with Sleep

When the FOSC Fail-Safe Clock Monitor is enabled (FCMEN Configuration bit = 1) and either the Primary or Secondary Fail-Safe Clock Monitor is also enabled (FCMENS and/or FCMENP = 1), putting the device to Sleep will cause a Fail-Safe condition to trigger. This has the effect of erroneously triggering Fail-Safe interrupts when there has not been a clock interruption. This can also cause the Watchdog Timer to not properly wake up the part from Sleep.

### Work around

If proper functionality in Sleep is required, do not enable the Primary or Secondary Fail-Safe Clock Monitor while the FOSC Fail-Safe Clock Monitor is enabled. If Primary or Secondary Clock Monitoring in Sleep is desired, disable the FOSC Fail-Safe Clock Monitor before the device goes to Sleep.

### Affected Silicon Revisions

A4	A5	A6	B1
X			

## 1.2.3 Maximum Clock Frequency for EC Mode Is 32 MHz for $V_{DD} < 2.0V$

When configured in External Clock High-Power (ECH) mode and operating at  $V_{DD} < 2.0V$ , the maximum input clock frequency is 32 MHz.

### Work around

To obtain a system clock frequency of 64 MHz in ECH mode at  $V_{DD} < 2.0V$ , use a 16 MHz external clock in conjunction with the 4x Phase-Locked Loop (PLL) circuit (i.e., either RSTOSC Configuration bits = 0b010 or OSCCON1bits.NOSC = 0b010).

### Affected Silicon Revisions

A4	A5	A6	B1
X			

## 1.3 Module: Inter-Integrated Circuit (I<sup>2</sup>C)

### 1.3.1 The I2CxADR0/1/2/3 Registers Have Incorrect Reset Value

The I2CxADR0/2 registers reset to 0xFF when the I2CxMD is enabled instead of 0x00. The I2CxADR1/3 registers reset to 0xFE when the I2CxMD is enabled instead of 0x00.

### Work around

None.

### Affected Silicon Revisions

A4	A5	A6	B1
X			

### 1.3.2 The I<sup>2</sup>C Start and/or Stop Flags May Be Set When I<sup>2</sup>C Is Enabled

When I<sup>2</sup>C is enabled, erroneous Start and/or Stop conditions may be detected. This can generate erroneous I<sup>2</sup>C interrupts if enabled.

### Work around

Use the following procedure to correctly detect the Start and Stop conditions:

1. Disable the Start and Stop conditions interrupt functions.
2. Enable the I<sup>2</sup>C module.
3. Wait 250 ns + six instruction cycles (F<sub>Osc</sub>/4).
4. Clear the Start and Stop conditions interrupt flags.
5. Enable the Start and Stop conditions interrupt functions if used.

```
I2CxPIEbits.SCIE = 0;           // Disable Start condition interrupt
I2CxPIEbits.PCIE = 0;           // Disable Stop condition interrupt
I2CxCON0bits.EN = 1;           // Enable I2C
Delay();                         // Wait for 250 ns + 6 instruction cycles (FOSC/4)
I2CxPIRbits.SCIF = 0;           // Clear the Start condition interrupt flags
I2CxPIRbits.PCIF = 0;           // Clear the Stop condition interrupt flags
I2CxPIEbits.SCIE = 1;           // Enable Start condition interrupt if used
I2CxPIEbits.PCIE = 1;           // Enable Stop condition interrupt if used
```

#### Affected Silicon Revisions

A4	A5	A6	B1
X	X		

#### 1.3.3 MDR Bit Is Not Cleared after Bus Timeout

In the Host mode of the I<sup>2</sup>C module, when a bus timeout occurs during clock stretching and TOREC = 1, the MDR bit will not be cleared and a Stop will not be transmitted on the bus.

##### Work around

Force a Stop on the bus by setting the P bit upon bus timeout in Host mode. Forcing a Stop on the bus clears the MDR bit.

#### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	X

#### 1.3.4 Bus Timeout Not Detected Properly when External Host Clock Stretches

When the module is operating in Client mode and an external Host device is clock stretching after the eighth SCL clock and a bus timeout occurs, the bus timeout is not detected properly. When the external Host times out before the Client and releases SCL to generate a Stop condition, the module continues to stretch SDA as if to generate an ACK and hangs the bus, and a Stop is never seen on the bus.

##### Work around

Reset the module by toggling the EN bit.

#### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	X

#### 1.3.5 Clock Stretch Disable Not Working Properly

When the CSD bit is set between a Start condition and the eighth falling SCL edge, the I<sup>2</sup>C module enters a state where the module clock stretches indefinitely after the next Start until a bus timeout occurs.

##### Work around

Force a reset of the module by toggling the EN bit.

#### Affected Silicon Revisions

A4	A5	A6	B1

X	X	X	X
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### 1.3.6 Bus Time-Out Causes False Start/Stop

When the module is operating in Client mode and an external Host device is clock stretching and a bus time-out occurs in the Client, the Client releases SDA and goes into the idle state. After the external Host generates a Stop condition on the bus by releasing SCL, the module can erroneously drive a low pulse on the SDA line, which acts as a false Start and Stop on the bus.

#### Work around

None.

#### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	X

### 1.3.7 CSTR Bit Is Not Cleared After Bus Time-Out

When the module is operating in Client mode and TOREC = 1 and a bus time-out occurs during clock stretching, the CSTR bit will not be cleared and the module continues to clock stretch and hang the bus.

#### Work around

Reset the I<sup>2</sup>C module by toggling the EN bit.

#### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	X

### 1.3.8 Operating in Multi-Host Mode Will Cause Bus Failures

If operating in Multi-Host mode and a second host drives SDA low at the same time the Start bit is generated, the module will fail to go into Host mode, but will continue to send an address and data as if it won arbitration. I2CCNT fails to decrement, and the module will remain in this state until a bus time-out occurs or the device is reset.

#### Work around

None.

#### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	X

## 1.4 Module: Operational Amplifier

### 1.4.1 The Charge Pump On Control (CPON) Bit Is Reserved

When not operating the OPA near the rails, the Charge Pump On Control (CPON) bit can be used to disable the charge pump in order to save on current consumption. This feature is currently not available, and the charge pump is always enabled whenever the OPA module is in operation.

#### Work around

None.

#### Affected Silicon Revisions

A4	A5	A6	B1
X			

#### 1.4.2 Internal Resistor Ladder Does Not Disconnect in Unity Gain Mode

When using the OPA module in a unity gain configuration, the internal resistor ladder will not automatically disconnect from the operational amplifier, which may adversely affect the gain of the circuit. This applies when the peripheral has been configured to operate in Unity Gain mode in software by setting the UG bit, or in hardware using the hardware controlled override feature.

##### Work around

Disconnect the internal resistor ladder from the operational amplifier by writing to the Inverting Input Channel Selection (NCH) bits. All signals can be disconnected from the operational amplifier by writing 0b000 to the NCH bits.

##### Affected Silicon Revisions

A4	A5	A6	B1
X			

### 1.5 Module: Universal Asynchronous Receiver Transmitter (UART)

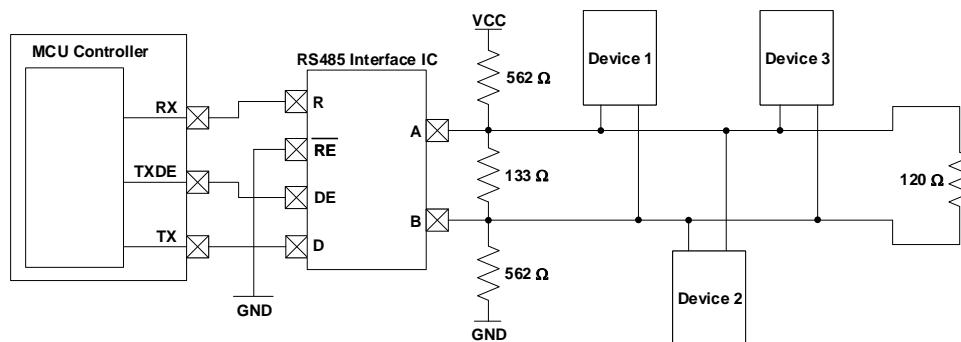
#### 1.5.1 UART TXDE Signal May Go Low Before the STOP Bit Has Been Entirely Transmitted

The UART Transmit Drive Enable (TXDE) signal could potentially transition into a low state before the UART STOP bit has been entirely transmitted due to the effects of parasitic capacitance on the TX line. In some applications, this could result in communication being prematurely terminated due to the TXDE bit going low before the STOP bit has had enough time to settle.

##### Work around

To ensure that the STOP bit settles into its final logic state before the TXDE signal transitions low, a biasing circuit can be implemented. A biasing circuit allows the TX line to either be driven high or low, rather than being left in a floating tri-state mode where prolonged rise or fall times could lead to communication being disrupted. This bias circuit should only be implemented on one end of the serial bus, and a termination resistor should be used on the other end. The figure below shows an example of a bias circuit that can be used to achieve this.

Please note that the resistor values used in this circuit are recommendations, and that the actual resistor values required may vary based on the application.



##### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	

#### 1.5.2 Asynchronous 9-bit UART Address Mode Address Mismatch

In Asynchronous 9-bit UART Address mode there is the possibility that a false address mismatch may occur even when the address of both devices match, or that a false address match may occur when there is an address mismatch between the devices.

## Work around

None. Do not use the UART modules in Asynchronous 9-bit Address Mode

## Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	X

## 1.6 Module: Signal Measurement Timer (SMT)

### 1.6.1 Reset Bit

If the SMT clock prescaler is set to any value other than '00', setting the RST bit will cause the module to stop working. The RST bit will remain at the value '1', the counter will not increment, and no interrupts will be generated. The problem is cleared by turning the module off and on or by performing a device reset.

## Work around

### Method 1:

Do not set the RST bit; manual reset is usually not required for typical operation because the measurement logic will reset the counter automatically.

### Method 2:

Write zero to the counter manually. Either disable the module or the clock before using this method.

### Method 3:

Use 1:1 prescaler (PS = 00).

### Method 4:

Use the CLKREF subsystem to provide a prescaled clock and set PS = 00.

## Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	

## 1.7 Module: PIC18 Core

### 1.7.1 FSR Shadow Registers Are Not Writable

Writing to the FSR Shadow Registers does not result in accurate values being stored in the registers. Consequently, reading the FSR Shadow Registers after they have been written will return inaccurate data.

## Work around

Writes to the FSR shadow registers can be performed safely using the following steps:

1. Save regular FSR2 value into RAM.
2. Write the regular FSR2 with the targeted value minus the computed offset (IR[6:0] + 1, see below).
3. Write the shadow FSRxL (data doesn't matter); this will clock the shadow FSR with the FSR computed offset value.
4. Decrement FSR2 value by 1 since FSRxH increments the address by 1 (IR[6:0]).
5. Write FSRxH.
6. Restore the regular FSR2 from the stored RAM value.

The FSR shadow should have the value desired and the regular FSR should have the original value.

### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	

## 1.8 Module: Low-Voltage In-Circuit Serial Programming™ (LVP)

### 1.8.1 Low-Voltage Programming Not Possible

Low-Voltage Programming is not possible when  $V_{DD}$  is below the selected BORV voltage level while BOR is enabled.

#### Work around

##### Method 1:

Disable BOR to use Low-Voltage Programming.

##### Method 2:

Raise  $V_{DD}$  above the selected BORV level while using Low-Voltage Programming.

### Affected Silicon Revisions

A4	A5	A6	B1
X	X	X	

## 2. Data Sheet Clarifications

The following typographic corrections and clarifications are to be noted for the latest version of the device data sheet (DS40002214E):

### Note:

Corrections are shown in **bold**. Where possible, the original bold text formatting has been removed for clarity.

### 2.1 None

There are no known data sheet clarifications as of this publication date.

### 3. Appendix A: Revision History

Doc Rev.	Date	Comments
F	08/2023	Adding Silicon Revision B1. Adding silicon errata items 1.3.3, 1.3.4, 1.3.5, 1.3.6, 1.3.7, 1.3.8 and 1.8.1.
E	04/2022	Updating the flash memory cell endurance specification data sheet clarification. Adding silicon errata item 1.7.1
D	02/2022	Adding silicon revision A6. Adding silicon errata items 1.1.2, 1.3.2, 1.5.1 and 1.6.1
C	11/2020	Adding silicon revision A5.
B	08/2020	Adding silicon errata item 1.5.1.
A	06/2020	Initial document release.

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